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Understanding Embedded - Microprocessors

Embedded microprocessors are specialized computing chips designed to perform specific tasks within an embedded system. Unlike general-purpose microprocessors found in personal computers, embedded microprocessors are tailored for dedicated functions within larger systems, offering optimized performance, efficiency, and reliability. These microprocessors are integral to the operation of countless electronic devices, providing the computational power necessary for controlling processes, handling data, and managing communications.

Applications of Embedded - Microprocessors

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

Details	
Product Status	Obsolete
Core Processor	Z8S180
Number of Cores/Bus Width	1 Core, 8-Bit
Speed	33MHz
Co-Processors/DSP	-
RAM Controllers	DRAM
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	-
SATA	-
USB	-
Voltage - I/O	5.0V
Operating Temperature	0°C ~ 70°C (TA)
Security Features	-
Package / Case	80-BQFP
Supplier Device Package	80-QFP
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8s18033fsc

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Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

Table 2. Pin Status During RESET, BUSACK, and SLEEP Modes (Continued)

Pin Number and Package Type				Pin Status			
QFP	PLCC	DIP	Default Function	Secondary Function	RESET	BUSACK	SLEEF
39	41	38	D4		3T	3T	3T
40	42	39	D5		3T	3T	3T
41	43	40	D6		3T	3T	3T
42			NC				
43			NC				
44	44	41	D7		3T	3T	3T
45	45	42	RTS0		High	OUT	High
46	46	43	CTS0		IN	OUT	IN
47	47	44	DCD0		IN	IN	IN
48	48	45	TXA0		High	OUT	OUT
49	49	46	RXA0		IN	IN	IN
50	50	47	CKA0		3T	I/O	I/O
			DREQ0		N/A	IN	IN
51			NC				
52	51	48	TXA1		High	OUT	OUT
53	52		TEST				
54	53	49	RXA1		IN	IN	IN
55	54	50	CKA1		3T	I/O	I/O
			TEND0		N/A	High	High
56	55	51	TXS		High	OUT	OUT
57	56	52	RXS		IN	IN	IN
			CTS1		N/A	IN	IN
58	57	53	CKS		3T	I/O	I/O
59	58	54	DREQ1		IN	3T	IN
60	59	55	TEND1		High	OUT	High
61	60	56	HALT		High	High	Low
62			NC				
63			NC				
64	61	57	RFSH		High	OUT	High
65	62	58	ĪORQ		High	3T	High
66	63	59	MREQ		High	3T	High
67	64	60	Е		Low	OUT	OUT
68	65	61	M1		High	High	High
69	66	62	WR		High	3T	High
70	67	63	RD		High	3T	High
71	68	64	PHI		OUT	OUT	OUT
72	1	1	V _{SS}		GND	GND	GND
73	2		V _{SS}		GND	GND	GND
74	3	2	XTAL		OUT	OUT	OUT
75			NC				

PIN IDENTIFICATION (Continued)

Table 2. Pin Status During RESET, BUSACK, and SLEEP Modes (Continued)

Pin Number and Package Type						Pin Status	
QFP	PLCC	DIP	Default Function	Secondary Function	RESET	BUSACK	SLEEP
76	4	3	EXTAL		IN	IN	IN
77	5	4	WAIT		IN	IN	IN
78	6	5	BUSACK		High	OUT	OUT
79	7	6	BUSREQ		IN	IN	IN
80	8	7	RESET		IN	IN	IN

PIN DESCRIPTIONS

A0–A19 Address Bus (Output, 3-state). A0–A19 form a 20-bit address bus. The Address Bus provides the address for memory data bus exchanges (up to 1 MB) and I/O data bus exchanges (up to 64 KB). The address bus enters a high–impedance state during reset and external bus acknowledge cycles. Address line A18 is multiplexed with the output of PRT channel 1 (T_{OUT}, selected as address output on reset), and address line A19 is not available in DIP versions of the Z8S180.

BUSACK. Bus Acknowledge (Output, active Low). BUSACK indicates that the requesting device, the MPU address and data bus, and some control signals enter their high-impedance state.

BUSREQ. Bus Request (Input, active Low). This input is used by external devices (such as DMA controllers) to request access to the system bus. This request demands a higher priority than $\overline{\text{NMI}}$ and is always recognized at the end of the current machine cycle. This signal stops the CPU from executing further instructions, places addresses, data buses, and other control signals into the high-impedance state.

CKAO, **CKA1**. Asynchronous Clock 0 and 1 (bidirectional). When in output mode, these pins are the transmit and receive clock outputs from the ASCI baud rate generators. When in input mode, these pins serve as the external clock inputs for the ASCI baud rate generators. CKAO is multiplexed with $\overline{\text{DREQO}}$, and CKA1 is multiplexed with $\overline{\text{TENDO}}$.

CKS. Serial Clock (bidirectional). This line is the clock for the CSI/O channel.

CTS0-**CTS1**. Clear to send 0 and 1 (Inputs, active Low). These lines are modem control signals for the ASCI channels. CTS1 is multiplexed with RXS.

D0–D7. Data Bus = (bidirectional, 3-state). D0–D7 constitute an 8-bit bidirectional data bus, used for the transfer of information to and from I/O and memory devices. The data bus enters the high-impedance state during reset and external bus acknowledge cycles.

DCDO. Data Carrier Detect 0 (Input, active Low); a programmable modem control signal for ASCI channel 0.

DREQO, DREQT. DMA Request 0 and 1 (Input, active Low). DREQ is used to request a DMA transfer from one of the on-chip DMA channels. The DMA channels monitor these inputs to determine when an external device is ready for a READ or WRITE operation. These inputs can be programmed to be either level or edge sensed. DREQO is multiplexed with CKAO.

E. Enable Clock (Output). This pin functions as a synchronous, machine-cycle clock output during bus transactions.

EXTAL. External Clock Crystal (Input). Crystal oscillator connections. An external clock can be input to the Z8S180/Z8L180 on this pin when a crystal is not used. This input is Schmitt triggered.

HALT. HALT/SLEEP (Output, active Low). This output is asserted after the CPU executes either the HALT or SLEEP instruction and is waiting for either a nonmaskable or a maskable interrupt before operation can resume. It is also used with the M1 and ST signals to decode the status of the CPU machine cycle.

INTO. Maskable Interrupt Request 0 (Input, active Low). This signal is generated by external I/O devices. The CPU honors these requests at the end of the current instruction cycle as long as the NMI and BUSREQ signals are inactive. The CPU acknowledges this interrupt request with an interrupt acknowledge cycle. During this cycle, both the M1 and \overline{IORQ} signals become active.

INT1, **INT2**. Maskable Interrupt Request 1 and 2 (Inputs, active Low). This signal is generated by external I/O devices. The CPU honors these requests at the end of the current instruction cycle as long as the NMI, BUSREQ, and INTO signals are inactive. The CPU acknowledges these requests with an interrupt acknowledge cycle. Unlike the acknowledgment for INTO, neither the MT or IORQ signals become active during this cycle.

 $\overline{\text{IORQ}}$. I/O Request (Output, active Low, 3-state). $\overline{\text{IORQ}}$ indicates that the address bus contains a valid I/O address for an I/O READ or I/O WRITE operation. $\overline{\text{IORQ}}$ is also generated, along with $\overline{\text{M1}}$, during the acknowledgment of the $\overline{\text{INTO}}$ input signal to indicate that an interrupt response vector can be place onto the data bus. This signal is analogous to the $\overline{\text{IOE}}$ signal of the Z64180.

M1. Machine Cycle 1 (Output, active Low). Together with MREQ, M1 indicates that the current cycle is the opcodefetch cycle of instruction execution. Together with IORQ, M1 indicates that the current cycle is for interrupt acknowledgment. It is also used with the HALT and ST signal to decode the status of the CPU machine cycle. This signal is analogous to the LIR signal of the Z64180.

MREQ. Memory Request (Output, active Low, 3-state). MREQ indicates that the address bus holds a valid address for a memory READ or memory WRITE operation. This signal is analogous to the ME signal of Z64180.

NMI. Nonmaskable Interrupt (Input, negative edge triggered). NMI demands a higher priority than INT and is al-

PIN DESCRIPTIONS (Continued)

ways recognized at the end of an instruction, regardless of the state of the interrupt-enable flip-flops. This signal forces CPU execution to continue at location 0066H.

PHI. System Clock (Output). The output is used as a reference clock for the MPU and the external system. The frequency of this output may be one-half, equal to, or twice the crystal or input clock frequency.

RD. Read (Output, active Low, 3-state). RD indicates that the CPU wants to read data from either memory or an I/O device. The addressed I/O or memory device should use this signal to gate data onto the CPU data bus.

RFSH. Refresh (Output, active Low). Together with MREQ, RFSH indicates that the current CPU machine cycle and the contents of the address bus should be used for refresh of dynamic memories. The low-order 8 bits of the address bus (A7–A0) contain the refresh address. *This signal is analogous to the REF signal of the Z64180*.

RTSO. Request to Send 0 (Output, active Low); a programmable MODEM control signal for ASCI channel 0.

RXA0, **RXA1**. Receive Data 0 and 1 (Input). These signals are the receive data for the ASCI channels.

RXS. Clocked Serial Receive Data (Input). This line is the receive data for the CSI/O channel. RXS is multiplexed with the CTS1 signal for ASCI channel 1.

ST. Status (Output). This signal is used with the $\overline{M1}$ and \overline{HALT} output to decode the status of the CPU machine cycle. See Table 3.

Table 3. Status Summary

ST	HALT	M1	Operation
0	1	0	CPU Operation (1st Opcode Fetch)
1	1	0	CPU Operation (2nd Opcode and 3rd Opcode Fetch)
1	1	1	CPU Operation (MC Except Opcode Fetch)
0	Χ	1	DMA Operation
0	0	0	HALT Mode
1	0	1	SLEEP Mode (Including SYSTEM STOP Mode)

Notes:

X = Do not care.

MC = Machine Cycle.

TENDO, **TEND1**. Transfer End 0 and 1 (Outputs, active Low). This output is asserted active during the most recent WRITE cycle of a DMA operation. It is used to indicate the end of the block transfer. **TENDO** is multiplexed with CKA1.

TEST. Test (Output, not in DIP version). This pin is for test and should be left open.

 T_{OUT} . Timer Out (Output). T_{OUT} is the output from PRT channel 1. This line is multiplexed with A18 of the address bus.

TXA0. TXA1. Transmit Data 0 and 1 (Outputs). These signals are the transmitted data from the ASCI channels. Transmitted data changes are with respect to the falling edge of the transmit clock.

TXS. Clocked Serial Transmit Data (Output). This line is the transmitted data from the CSI/O channel.

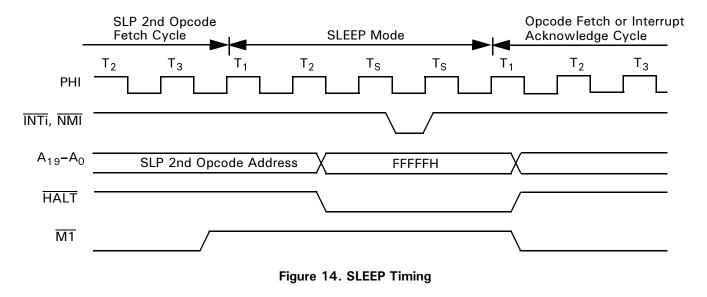
WAIT. Wait (Input, active Low). WAIT indicates to the MPU that the addressed memory or I/O devices are not ready for data transfer. This input is sampled on the falling edge of T2 (and subsequent WAIT states). If the input is sampled Low, then the additional WAIT states are inserted until the WAIT input is sampled High, at which time execution continues.

WR. WRITE (Output, active Low, 3-state). WR indicates that the CPU data bus holds valid data to be stored at the addressed I/O or memory location.

XTAL. Crystal Oscillator Connection (Input). This pin should be left open if an external clock is used instead of a crystal. The oscillator input is not a TTL level (see <u>DC Characteristics</u>).

Several pins are used for different conditions, depending on the circumstance. This condition provides a technique for synchronization with high-speed external events without incurring the latency imposed by an interrupt-response sequence. Figure 14 depicts the timing for exiting SLEEP mode due to an interrupt request.

Note: The Z8S180/Z8L180 takes about 1.5 clock ticks to restart.



IOSTOP Mode. IOSTOP mode is entered by setting the IOSTOP bit of the I/O Control Register (ICR) to 1. In this case, on-chip I/O (ASCI, CSI/O, PRT) stops operating. However, the CPU continues to operate. Recovery from IOSTOP mode is performed by resetting the IOSTOP bit in ICR to 0.

SYSTEM STOP Mode. SYSTEM STOP mode is the combination of SLEEP and IOSTOP modes. SYSTEM STOP mode is entered by setting the IOSTOP bit in ICR to 1 followed by execution of the SLP instruction. In this mode, onchip I/O and CPU stop operating, reducing power consumption, but the PHI output continues to operate. Recovery from SYSTEM STOP mode is the same as recovery from SLEEP mode except that internal I/O sources (disabled by IOSTOP) cannot generate a recovery interrupt.

IDLE Mode. Software puts the Z8S180/Z8L180 into this mode by performing the following actions:

- Set the IOSTOP bit (ICR5) to 1
- Set CCR6 to 0
- Set CCR3 to 1
- Execute the SLP instruction

The oscillator keeps operating but its output is blocked to all circuitry including the PHI pin. DRAM refresh and all

internal devices stop, but external interrupts can occur. Bus granting to external Masters can occur if the BREST bit in the CPU control Register (CCR5) was set to 1 before IDLE mode was entered.

The Z8S180/Z8L180 leaves IDLE mode in response to a Low on $\overline{\text{RESET}}$, an external interrupt request on $\overline{\text{NMI}}$, or an external interrupt request on $\overline{\text{INT0}}$, $\overline{\text{INT1}}$ or $\overline{\text{INT2}}$ that is enabled in the INT/TRAP Control Register. As previously described for SLEEP mode, when the Z8S180/Z8L180 leaves IDLE mode due to an $\overline{\text{NMI}}$, or due to an enabled external interrupt request when the $\overline{\text{IEF}}$ flag is 1 due to an EI instruction, the device starts by performing the interrupt with the return address of the instruction after the SLP instruction.

If an external interrupt enables the INT/TRAP control register while the IEF1 bit is 0, Z8S180/Z8L180 leaves IDLE mode; specifically, the processor restarts by executing the instructions following the SLP instruction.

Figure 15 indicates the timing for exiting IDLE mode due to an interrupt request.

Note: The Z8S180/Z8L180 takes about 9.5 clocks to restart.

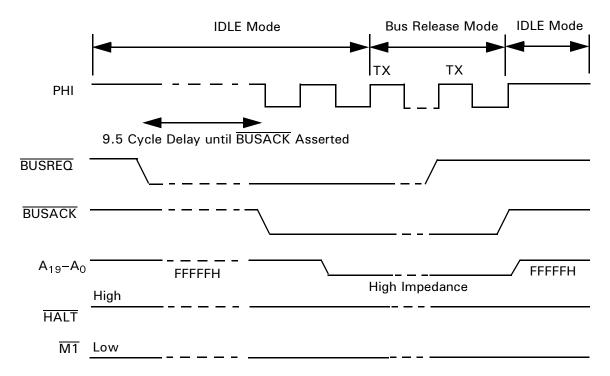


Figure 16. Bus Granting to External Master in IDLE Mode

STANDBY Mode (With or Without QUICK RECOVERY).

Software can put the Z8S180/Z8L180 into this mode by setting the IOSTOP bit (ICR5) to 1, CCR6 to 1, and executing the SLP instruction. This mode stops the on-chip oscillator and thus draws the least power of any mode, less than $10\mu A$.

As with IDLE mode, the Z8S180/Z8L180 leaves STANDBY mode in response to a Low on $\overline{\text{RESET}}$, on $\overline{\text{NMI}}$, or a Low on $\overline{\text{INTO-2}}$ that is enabled by a 1 in the corresponding bit in the INT/TRAP Control Register. This action grants the bus to an external Master if the BREXT bit in the CPU Control Register (CCR5) is 1. The time required for all of these operations is greatly increased by the necessity for restarting the on-chip oscillator, and ensuring that it stabilizes to square-wave operation.

When an external clock is connected to the EXTAL pin rather than a crystal to the XTAL and EXTAL pins and the external clock runs continuously, there is little necessity to use STANDBY mode because no time is required to restart the oscillator, and other modes restart faster. However, if external logic stops the clock during STANDBY mode (for example, by decoding HALT Low and M1 High for several clock cycles), then STANDBY mode can be useful to allow the external clock source to stabilize after it is re-enabled.

When external logic drives RESET Low to bring the device out of STANDBY mode, and a crystal is in use or an external clock source is stopped, the external logic must hold RESET Low until the on-chip oscillator or external clock source is restarted and stabilized.

The clock-stability requirements of the Z8S180/Z8L180 are much less in the divide-by-two mode that is selected by a RESET sequence and controlled by the Clock Divide bit in the CPU Control Register (CCR7). As a result, software performs the following actions:

- 1. Sets CCR7 to 0 for divide-by-two mode before an SLP instruction and STANDBY mode.
- Delays setting CCR7 back to 1 for divide-by-one mode as long as possible to allow additional clock stabilization time after a RESET, interrupt, or in-line RESTART after an SLP 01 instruction.

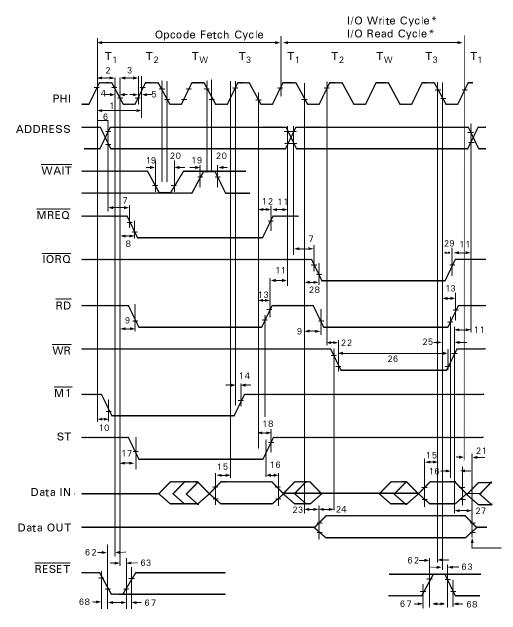
If CCR6 is set to 1 before the SLP instruction places the MPU in STANDBY mode, the value of the CCR3 bit determines the length of the delay before the oscillator restarts and stabilizes when it leaves STANDBY mode due to an external interrupt request. When CCR3 is 0, the Z8S180/Z8L180 waits 2¹⁷ (131,072) clock cycles. When CCR3 is 1, it waits 64 clock cycles. This state is called QUICK RECOVERY mode. The same delay applies to grant-

AC CHARACTERISTICS—Z8S180 (Continued)

Table 8. Z8S180 AC Characteristics (Continued) $V_{DD}=5V\pm10\%$ or $V_{DD}=3.3V\pm10\%$; 33-MHz Characteristics Apply Only to 5V Operation

			Z8S180	_20 MHz	Z8S180	-33 MHz	
Number	Symbol	Item	Min	Max	Min	Max	Unit
32	t _{INTH}	INT Hold Time from PHI Fall	10	_	10	_	ns
33	t _{NMIW}	NMI Pulse Width	35	_	25	_	ns
34	t _{BRS}	BUSREQ Set-up Time to PHI Fall	10	_	10	_	ns
35	t _{BRH}	BUSREQ Hold Time from PHI Fall	10	_	10		ns
36	t _{BAD1}	PHI Rise to BUSACK Fall Delay	_	25	_	15	ns
37	t _{BAD2}	PHI Fall to BUSACK Rise Delay	_	25	_	15	ns
38	t _{BZD}	PHI Rise to Bus Floating Delay Time		40	_	30	ns
39	t _{MEWH}	MREQ Pulse Width (High)	35	_	25	_	ns
40	t _{MEWL}	MREQ Pulse Width (Low)	35	_	25	_	ns
41	t _{RFD1}	PHI Rise to RFSH Fall Delay	_	20	_	15	ns
42	t _{RFD2}	PHI Rise to RFSH Rise Delay	_	20	_	15	ns
43	t _{HAD1}	PHI Rise to HALT Fall Delay	_	15	_	15	ns
44	t _{HAD2}	PHI Rise to HALT Rise Delay	_	15	_	15	ns
45	t _{DRQS}	DREQ1 Set-up Time to PHI Rise	20	_	15	_	ns
46	t _{DRQH}	DREQ1 Hold Time from PHI Rise	20	_	15	_	ns
47	t _{TED1}	PHI Fall to TENDi Fall Delay	_	25	_	15	ns
48	t _{TED2}	PHI Fall to TENDi Rise Delay	_	25	_	15	ns
49	t _{ED1}	PHI Rise to E Rise Delay	_	30	_	15	ns
50	t _{ED2}	PHI Fall or Rise to E Fall Delay	_	30	_	15	ns
51	P _{WEH}	E Pulse Width (High)	25	_	20	_	ns
52	P _{WEL}	E Pulse Width (Low)	50	_	40	_	ns
53	t _{Er}	Enable Rise Time	_	10	_	10	ns
54	t _{Ef}	Enable Fall Time	_	10	_	10	ns
55	t _{TOD}	PHI Fall to Timer Output Delay	_	75	_	50	ns
56	t _{STDI}	CSI/O Transmit Data Delay Time (Internal Clock Operation)	_	2	_	2	tcyc
57	t _{STDE}	CSI/O Transmit Data Delay Time (External Clock Operation)	_	7.5 t _{CYC} +75	-	75 t _{CYC} +60	ns
58	t _{SRSI}	CSI/O Receive Data Set-up Time (Internal Clock Operation)	1	_	1	_	tcyc
59	t _{SRHI}	CSI/O Receive Data Hold Time (Internal Clock Operation)	1	_	1	_	tcyc
60	t _{SRSE}	CSI/O Receive Data Set-up Time (External Clock Operation)	1	_	1	_	tcyc
61	t _{SRHE}	CSI/O Receive Data Hold Time (External Clock Operation)	1	—	1	_	tcyc
62	t _{RES}	RESET Set-up Time to PHI Fall	40	_	25	_	ns

TIMING DIAGRAMS



Note: *Memory Read/Write Cycle timing is the same as I/O Read/Write Cycle except there are no automatic wait states (T_W) , and \overline{MREQ} is active instead of \overline{IORQ} .

Figure 20. CPU Timing
(Opcode Fetch Cycle, Memory Read Cycle,
Memory Write Cycle, I/O Write Cycle, I/O Read Cycle)

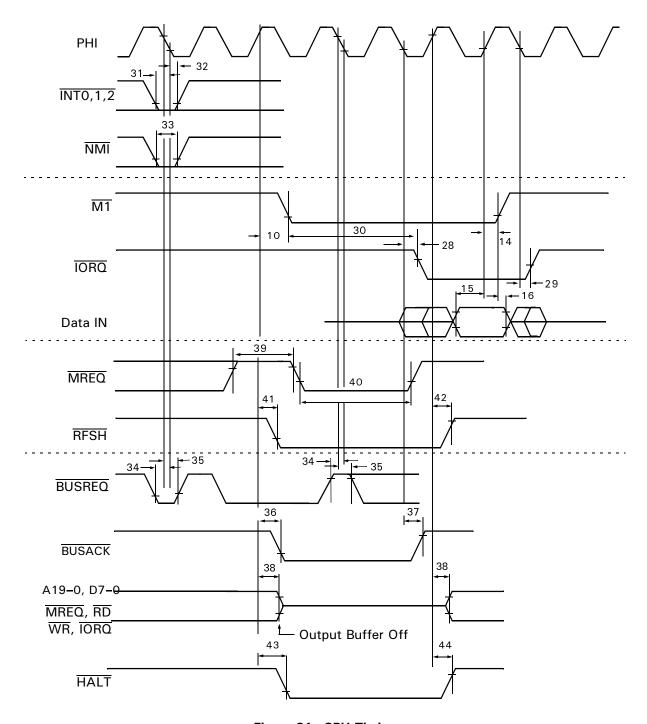


Figure 21. CPU Timing
(INTO Acknowledge Cycle, Refresh Cycle, BUS RELEASE Mode, HALT Mode, SLEEP Mode, SYSTEM STOP Mode)

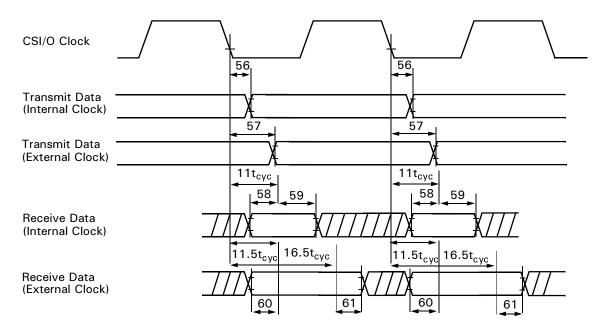


Figure 29. CSI/O Receive/Transmit Timing



Figure 30. Rise Time and Fall Times

ASCI REGISTER DESCRIPTION

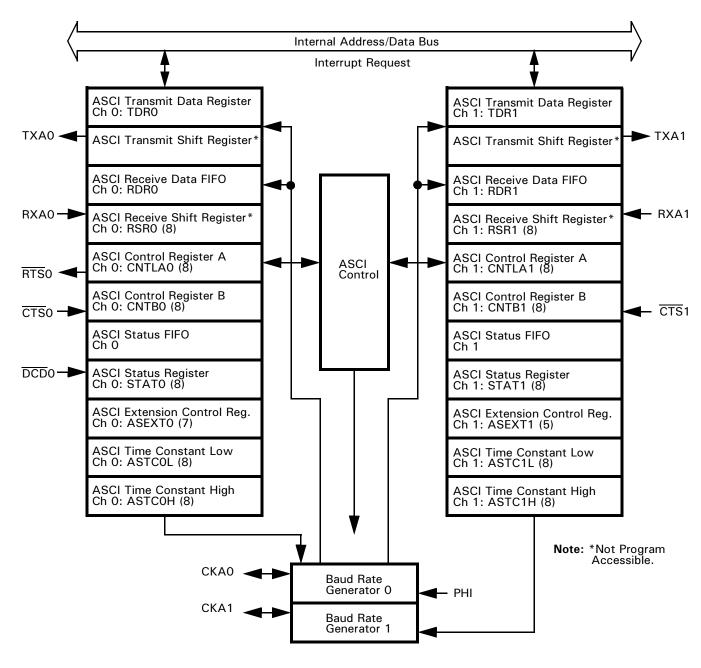


Figure 32. ASCI Block Diagram

ASCI Transmit Shift Register 0,1. When the ASCI Transmit Shift Register (TSR) receives data from the ASCI Transmit Data Register (TDR), the data is shifted out to the TXA pin. When transmission is completed, the next byte (if available) is automatically loaded from TDR into TSR and the next transmission starts. If no data is available for trans-

mission, TSR idles by outputting a continuous High level. This register is not program-accessible

ASCI Transmit Data Register 0,1 (TDR0, 1: I/O address = 06H, 07H). Data written to the ASCI Transmit Data Register is transferred to the TSR as soon as TSR is empty. Data can be written while TSR is shifting out the previous byte of data. Thus, the ASCI transmitter is double buffered.

Data can be written into and read from the ASCI Transmit Data Register. If data is read from the ASCI Transmit Data Register, the ASCI data transmit operation is not affected by this READ operation.

ASCI Receive Shift Register 0,1 (RSR0,1). This register receives data shifted in on the RXA pin. When full, data is automatically transferred to the ASCI Receive Data Register (RDR) if it is empty. If RSR is not empty when the next incoming data byte is shifted in, an overrun error occurs. This register is not program accessible.

ASCI Receive Data FIFO 0,1 (RDR0, 1:I/O Address = 08H, 09H). The ASCI Receive Data Register is a read-only register. When a complete incoming data byte is assembled in RSR, it is automatically transferred to the 4 character Receive Data First-In First-Out (FIFO) memory. The oldest character in the FIFO (if any) can be read from the Receive Data Register (RDR). The next incoming data byte can be shifted into RSR while the FIFO is full. Thus, the ASCI receiver is well buffered.

ASCI STATUS FIFO

This four-entry FIFO contains Parity Error, Framing Error, Rx Overrun, and Break status bits associated with each char-

acter in the receive data FIFO. The status of the oldest character (if any) can be read from the ASCI status registers.

ASCI CHANNEL CONTROL REGISTER A

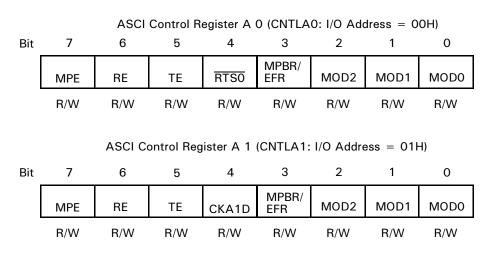


Figure 33. ASCI Channel Control Register A

MPE: Multi-Processor Mode Enable (Bit 7). The ASCI features a multiprocessor communication mode that utilizes an extra data bit for selective communication when a number of processors share a common serial bus. Multiprocessor data format is selected when the MP bit in CNTLB is set to 1. If multiprocessor mode is not selected (MP bit in CNTLB = 0), MPE has no effect. If multiprocessor mode is selected, MPE enables or disables the *wake-up* feature as follows. If MBE is set to 1, only received bytes in which the multiprocessor bit (MPB) = 1 can affect the RDRF and error flags. Effectively, other bytes (with MPB = 0) are *ignored* by the ASCI. If MPE is reset to 0, all bytes, regardless of

the state of the MPB data bit, affect the REDR and error flags. MPE is cleared to 0 during RESET.

RE: Receiver Enable (Bit 6). When RE is set to 1, the ASCI transmitter is enabled. When TE is reset to 0, the transmitter is disables and any transmit operation in progress is interrupted. However, the TDRE flag is not reset and the previous contents of TDRE are held. TE is cleared to 0 in IOSTOP mode during RESET.

TE: Transmitter Enable (Bit 5). When TE is set to 1, the ASCI receiver is enabled. When $\overline{\text{TE}}$ is reset to 0, the transmitter is disabled and any transmit operation in progress is interrupted. However, the TDRE flag is not reset and the pre-

ASCI RECEIVE REGISTER

Register addresses 08H and 09H hold the ASCI receive data for channel 0 and channel 1, respectively.

ASCI Receive Register Channel 0

Mnemonic RDR0 Address 08H

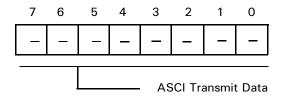


Figure 38. ASCI Receive Register Channel 0

ASCI Receive Register Channel 1

Mnemonic RDR1 Address 09H

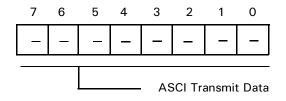


Figure 39. ASCI Receive Register Channel 1

CSI/O CONTROL/STATUS REGISTER

The CSI/O Control/Status Register (CNTR) is used to monitor CSI/O status, enable and disable the CSI/O, enable and

disable interrupt generation, and select the data clock speed and source.

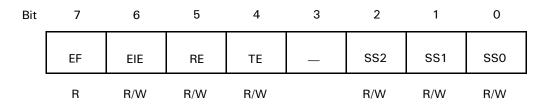


Figure 40. CSI/O Control Register (CNTR: I/O Address = 000AH)

EF: End Flag (Bit 7). EF is set to 1 by the CSI/O to indicate completion of an 8-bit data transmit or receive operation. If End Interrupt Enable (EIE) bit = 1 when EF is set to 1, a CPU interrupt request is generated. Program access of TRDR only occurs if EF = 1. The CSI/O clears EF to 0 when TRDR is read or written. EF is cleared to 0 during RESET and IOSTOP mode.

EIE: End Interrupt Enable (Bit 6). EIE is set to 1 to generate a CPU interrupt request. The interrupt request is inhibited if EIE is reset to 0. EIE is cleared to 0 during RESET.

RE: Receive Enable (Bit 5). A CSI/O receive operation is started by setting RE to 1. When RE is set to 1, the data clock is enabled. In internal clock mode, the data clock is output from the CKS pin. In external clock mode, the clock is input on the CKS pin. In either case, data is shifted in on the RXS

pin in synchronization with the (internal or external) data clock. After receiving 8 bits of data, the CSI/O automatically clears RE to 0, EF is set to 1, and an interrupt (if enabled by EIE = 1) is generated. RE and TE are never both set to 1 at the same time. RE is cleared to 0 during RESET and IOSTOP mode.

TE: Transmit Enable (Bit 4). A CSI/O transmit operation is started by setting TE to 1. When TE is set to 1, the data clock is enabled. When in internal clock mode, the data clock is output from the CKS pin. In external clock mode, the clock is input on the CKS pin. In either case, data is shifted out on the TXS pin synchronous with the (internal or external) data clock. After transmitting 8 bits of data, the CSI/O automatically clears TE to 0, sets EF to 1, and requests an interrupt if enabled by EIE = 1. TE and RE are

ASCI EXTENSION CONTROL REGISTER CHANNEL 0 AND CHANNEL 1 (Continued)

Timer Data Register Channel 1 Low

Mnemonic TMDR1L Address 14H

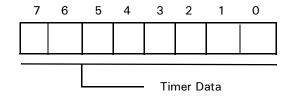


Figure 48. Timer Data Register 1 Low

Timer Reload Register Channel 1 High

Mnemonic RLDR1H Address 17H

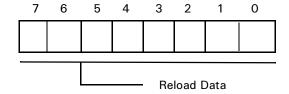


Figure 51. Timer Reload Register Channel 1 High

Timer Data Register Channel 1 High

Mnemonic TMDR1H Address 15H

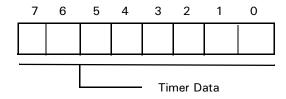


Figure 49. Timer Data Register 1 High

Free Running Counter (Read Only)

Mnemonic FRC Address 18H

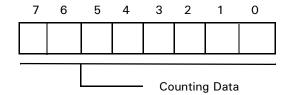


Figure 52. Free Running Counter

Timer Reload Register Channel 1 Low

Mnemonic RLDR1L Address 16

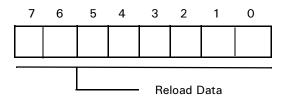


Figure 50. Timer Reload Channel 1 Low

ASCI TIME CONSTANT REGISTERS

If the SS2-0 bits of the CNTLB register are not 111, and the BRG mode bit in the ASEXT register is 1, the ASCI divides the PHI clock by two times the registers' 16-bit value, plus two. As a result, the clock is presented to the transmitter and receiver for division by 1, 16, or 64, and is output on the CKA pin.

If the SS2-0 bits in an ASCI CNTLB register are not 111, and the BRG mode bit in its Extension Control Register is 1, its *new* baud rate generator divides PHI for serial clocking, as follows:

bits/second =
$$f_{PHI}/(2*(TC+2) \times sampling rate)$$

where TC is the 16-bit value programmed into the ASCI Time Constant High and Low registers. If the ASCI multiplexed CKA pin is selected for the CKA function, it outputs the clock before the final division by the sampling rate, as follows:

$$f_{CKAout} = f_{PHI}/(2*(TC+2))$$

Find the TC value for a particular serial bit rate as follows:

$$TC = (f_{PHI}/(2 \text{ x bits/second x sampling rate})) - 2$$

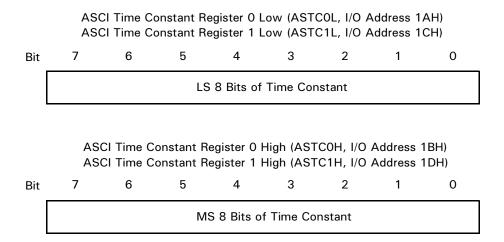


Figure 53. ASCI Time Constant Registers

DMA STATUS REGISTER

The DMA Status Register (DSTAT) is used to enable and disable DMA transfer and DMA termination interrupts.

DSTAT also indicates DMA transfer status, Completed or In Progress.

DMA Status Register

Mnemonic DSTAT Address 30H

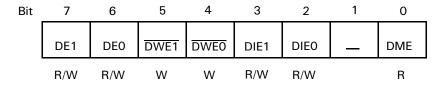


Figure 71. DMA Status Register (DSTAT: I/O Address = 30H)

DE1: DMA Enable Channel 1 (Bit 7). When DE1 = 1 and DME = 1, channel 1 DMA is enabled. When a DMA transfer terminates (BCR1 = 0), DE1 is reset to 0 by the DMAC. When DE1 = 0 and the DMA interrupt is enabled (DIE1 = 1), a DMA interrupt request is made to the CPU.

To perform a software WRITE to DE1, DWE1 should be written with a 0 during the same register WRITE access. Writing DE1 to 0 disables channel 1 DMA, but DMA is restartable. Writing DE1 to 1 enables channel 1 DMA and automatically sets DMA Main Enable (DME) to 1. DE1 is cleared to 0 during RESET.

DEO: DMA Enable Channel 0 (Bit 6). When DE0 = 1 and DME = 1, channel 0 DMA is enabled. When a DMA transfer terminates (BCRO = 0), DE0 is reset to 0 by the DMAC. When DE0 = 0 and the DMA interrupt is enabled (DIE0 = 1), a DMA interrupt request is made to the CPU.

To perform a software WRITE to DEO, $\overline{\text{DWEO}}$ should be written with 0 during the same register WRITE access. Writing DEO to 0 disables channel 0 DMA. Writing DEO to 1 enables channel 0 DMA and automatically sets DMA Main Enable (DME) to 1. DEO is cleared to 0 during RESET.

DWE1: DE1 Bit Write Enable (**Bit 5**). When performing any software WRITE to DE1, this bit should be written with 0 during the same access. DWE1 always reads as 1.

DWEO: DEO Bit Write Enable (Bit 4). When performing any software WRITE to DEO, this bit should be written with 0 during the same access. DWEO always reads as 1.

DIE1: DMA Interrupt Enable Channel 1 (Bit 3). When DIE0 is set to 1, the termination channel 1 DMA transfer (indicated when DE1 = 0) causes a CPU interrupt request to be generated. When DIE0 = 0, the channel 0 DMA termination interrupt is disabled. DIE0 is cleared to 0 during RESET.

DIEO: DMA Interrupt Enable Channel 0 (Bit 2). When DIEO is set to 1, the termination channel 0 of DMA transfer (indicated when DEO = 0) causes a CPU interrupt request to be generated. When DIEO = 0, the channel 0 DMA termination interrupt is disabled. DIEO is cleared to 0 during RESET.

DME: DMA Main Enable (Bit 0). A DMA operation is only enabled when its DE bit (DE0 for channel 0, DE1 for channel 1) and the DME bit is set to 1.

When NMI occurs, DME is reset to 0, thus disabling DMA activity during the NMI interrupt service routine. To restart DMA, DE- and/or DE1 should be written with a 1 (even if the contents are already 1). This condition automatically sets DME to 1, allowing DMA operations to continue.

Note: DME cannot be directly written. The bit is cleared to 0 by NMI or indirectly set to 1 by setting DEO and/or DE1 to 1. DME is cleared to 0 during RESET.

DMA/WAIT CONTROL REGISTER

The DMA/WAIT Control Register (DCNTL) controls the insertion of wait states into DMAC (and CPU) accesses of memory or I/O. Also, the register defines the Request signal

for each channel as level or edge sense. DCNTL also sets the DMA transfer mode for channel 1, which is limited to memory to/from I/O transfers.

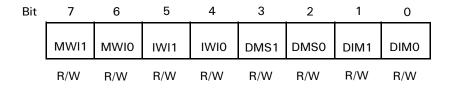


Figure 73. DMA/WAIT Control Register (DCNTL: I/O Address = 32H)

MWI1, MWI0: Memory Wait Insertion (Bits 7–6). This bit specifies the number of wait states introduced into CPU or DMAC memory access cycles. MWI1 and MWI0 are set to 1 during RESET.

MWI1	MWIO	Wait State
0	0	0
0	1	1
1	0	2
1	1	3

IWI1, IWI0: I/O Wait Insertion (Bits 5–4). This bit specifies the number of wait states introduced into CPU or DMAC I/O access cycles. IWI1 and IWI0 are set to 1 during RESET.

IWIO	Wait State
0	1
1	2
0	3
1	4
	0 1 0 1

Note: These wait states are added to the 3-clock I/O cycle that is used to access the on-chip I/O registers. It is equally valid to regard these as 0 to 3 wait states added to a 4-clock external I/O cycle.

DMS1, **DMS0**: **DMA** Request Sense (Bits 3–2). DMS1 and DMS0 specify the DMA request sense for channel 0 and channel 1 respectively. When reset to 0, the input is level sense. When set to 1, the input is edge sense. DMS1 and DMS0 are cleared to 0 during RESET.

DMSi	Sense
1	Edge Sense
0	Level Sense

Typically, for an input/source device, the associated DMS bit should be programmed as 0 for level sense. The device takes a relatively long time to update its Request signal after the DMA channel reads data (in the first of the two machine cycles involved in transferring a byte).

An output/destination device takes much less time to update its Request signal after the DMA channel starts a WRITE operation to it (the second machine cycle of the two cycles involved in transferring a byte). With zero-wait state I/O cycles, a device cannot update its request signal in the required time, so edge sensing must be used.

A one-wait-state I/O cycle also does not provide sufficient time for updating, so edge sensing is again required.

DIM1, **DIM0**: **DMA** Channel 1 I/O and Memory Mode (Bits 1–0). Specifies the source/destination and address modifier for channel 1 memory to/from I/O transfer modes. DIM1 and DIM0 are cleared to 0 during RESET.

Table 17. Channel 1 Transfer Mode

DIM1	DMIO	Transfer Mode	Address Increment/Decrement
DIIVI	DIVIIO	Transfer Wiode	mcrement/Decrement
0	0	Memory→I/O	MAR1 +1, IAR1 fixed
0	1	Memory→I/O	MAR1 -1, IAR1 fixed
1	0	I/O→Memory	IAR1 fixed, MAR1 +1
1	1	I/O→Memory	IAR1 fixed, MAR1 -1

All TRAPs occur after fetching an undefined second opcode byte following one of the prefix opcodes (CBH, DDH, EDH, or FDH) or after fetching an undefined third opcode byte following one of the double-prefix opcodes (DDCBH or FDCBH).

The state of the Undefined Fetch Object (UFO) bit in ITC allows TRAP software to correctly *adjust* the stacked PC, depending on whether the second or third byte of the opcode generated the TRAP. If UFO = 0, the starting address of the invalid instruction is the stacked PC-1. If UFO = 1, the starting address of the invalid instruction is equal to the stacked PC-2.

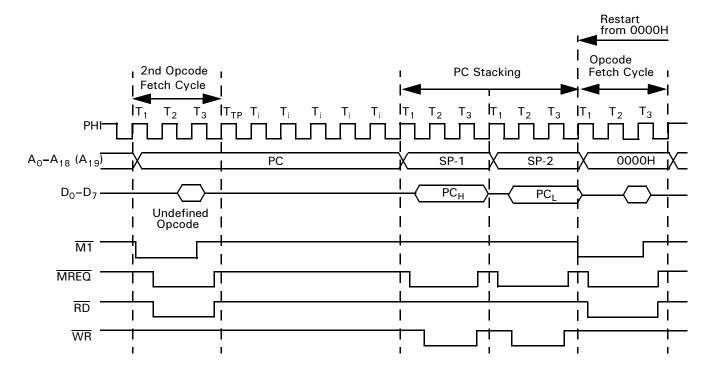


Figure 75. TRAP Timing - 2nd Opcode Undefined

MMU COMMON BASE REGISTER

The Common Base Register (CBR) specifies the base address (on 4-KB boundaries) used to generate a 20-bit phys-

ical address for Common Area 1 accesses. All bits of CBR are reset to 0 during RESET.

MMU Common Base Register

Mnemonic CBR Address 38H

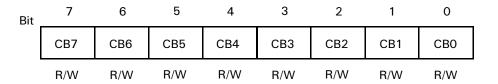


Figure 78. MMU Common Base Register (CBR: I/O Address = 38H)

MMU BANK BASE REGISTER

The Bank Base Register (BBR) specifies the base address (on 4-KB boundaries) used to generate a 20-bit physical ad-

dress for Bank Area accesses. All bits of BBR are reset to 0 during RESET.

MMU Bank Base Register

Mnemonic BBR Address 39H

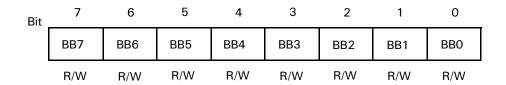


Figure 79. MMU Bank Base Register (BBR: I/O Address = 39H)

MMU COMMON/BANK AREA REGISTER

The Common/Bank Area Register (CBAR) specifies boundaries within the Z8S180/Z8L180 64-KB logical address

space for up to three areas; Common Area), Bank Area and Common Area 1.

MMU Common/Bank Area Register

Mnemonic CBAR Address 3AH

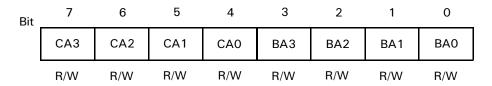


Figure 80. MMU Common/Bank Area Register (CBAR: I/O Address = 3AH)

CA3–CA0:CA (Bits 7–4). CA specifies the start (Low) address (on 4-KB boundaries) for Common Area 1. This condition also determines the most recent address of the Bank Area. All bits of CA are set to 1 during RESET.

BA3-BA0 (Bits 3-0). BA specifies the start (Low) address (on 4-KB boundaries) for the Bank Area. This condition also determines the most recent address of Common Area 0. All bits of BA are set to 1 during RESET.

OPERATION MODE CONTROL REGISTER

The Z8S180/Z8L180 is descended from two different ancestor processors, ZiLOG's original Z80 and the Hitachi 64180. The Operating Mode Control Register (OMCR) can be programmed to select between certain differences between the Z80 and the 64180.

Operation Mode Control Register

Mnemonic OMCR Address 3EH

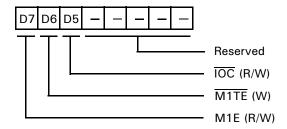


Figure 81. Operating Control Register (OMCR: I/O Address = 3EH)

M1E ($\overline{M1}$ Enable). This bit controls the $\overline{M1}$ output and is set to a 1 during reset.

When M1E = 1, the $\overline{\text{M1}}$ output is asserted Low during the opcode fetch cycle, the $\overline{\text{INTO}}$ acknowledge cycle, and the first machine cycle of the $\overline{\text{NMI}}$ acknowledge.

On the Z8S180/Z8L180, this choice makes the processor fetch one RETI instruction. When fetching a RETI from zero-wait-state memory, the processor uses three clock machine cycles that are not fully Z80-timing-compatible.

When M1E = 0, the processor does not drive $\overline{\text{M1}}$ Low during instruction fetch cycles. After fetching one RETI instruction with normal timing, the processor returns and refetches the instruction using Z80-compatible cycles that drive $\overline{\text{M1}}$ Low. This timing compatibility may be required by external Z80 peripherals to properly decode the RETI instruction.

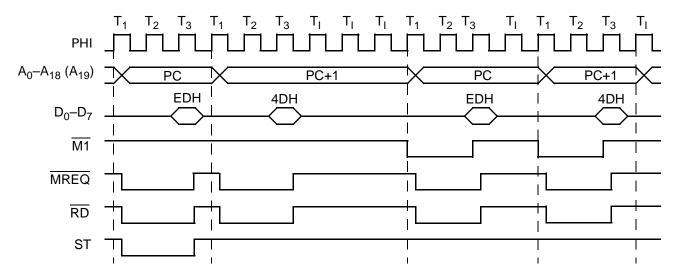


Figure 82. RETI Instruction Sequence with M1E = 0